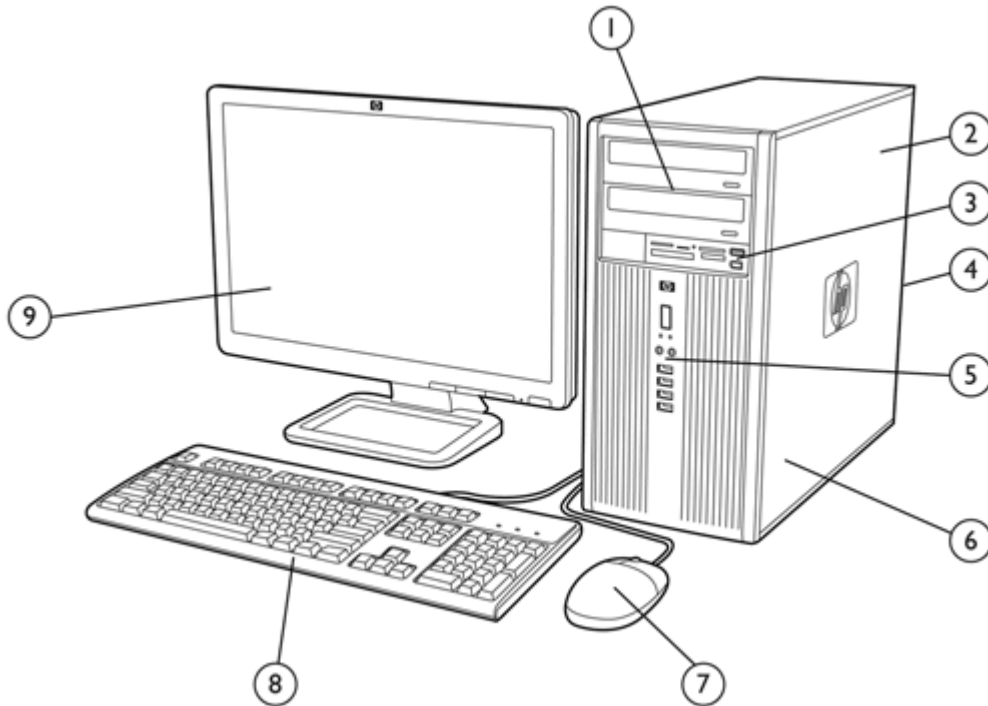


Overview

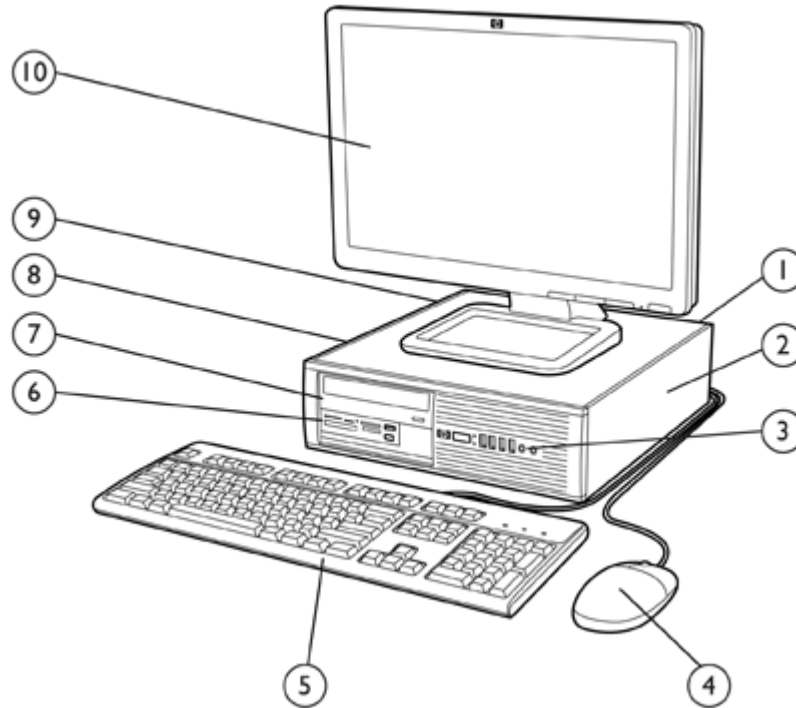
Microtower



1. (2) 5.25" external optical disk drive bays
(2) 3.5" internal hard disk drive bays
2. 320-watt standard efficiency power supply, Active Power Factor Correction (PFC)
Optional: 89% efficient energy saving power supply
3. (1) 3.5" external bay for optional HP 22-in-1 Media Card Reader, pocket media drive, or other 3.5" device
4. Rear I/O: (6) USB 2.0, (1) standard serial port, (1) optional serial port, (1) optional parallel port, (2) PS/2, (1) RJ-45, (1) VGA, (1) audio in, (1) audio out, (1) Display Port
5. Front I/O: (4) USB 2.0, headphone and microphone, Dual Colour Diagnostic LEDs
6. (1) full-height PCI slot, (2) full-height PCIe x1 slots, (1) full-height PCIe x16 (ADD2/SDVO) slot
7. HP Optical Scroll Mouse (PS/2 or USB), or HP USB Laser Mouse
8. HP Standard Keyboard (PS/2 or USB) or HP USB Smartcard Keyboard
9. HP monitor (sold separately)

Overview

Small Form Factor



1. Rear I/O: (6) USB 2.0, (1) standard serial port, (1) optional serial port, (1) optional parallel port, (2) PS/2, (1) RJ-45, (1) VGA, audio in/out, (1) DisplayPort
2. (1) low profile PCI slot, (2) low profile PCIe x1 slots, (1) low profile PCIe x16 (SDVO/ADD2) slot
3. Front I/O: (4) USB 2.0, headphone and microphone, Dual Color Diagnostic LEDs
4. HP Optical Scroll Mouse (PS/2 or USB), or HP USB Laser Mouse
5. HP Standard Keyboard (PS/2 or USB) or HP USB Smartcard Keyboard
6. (1) 3.5" external bay for optional HP 22-in-1 Media Card Reader, pocket media drive, or other 3.5" device
7. (1) 5.25" external bay for optional optical drive, or other 5.25" device (bay tilts up for device removal and insertion)
8. (1) 3.5-inch internal drive bay supporting primary hard disk drive
9. 240-watt power supply
Optional: 89% efficient energy saving power supply
10. HP Monitor (sold separately)

Overview

At A Glance

- The HP Compaq 6000 Pro Business PC is designed to be the foundation of your business with enhanced features and proven technology
- Intel® Q43 Express chipset, Intel Core™ 2 Duo processors, Intel Core 2 Quad processors, and Intel Graphics Media Accelerator 4500 integrated graphics
- Embedded TPM1.2 compliant security module* (Vista Bit-Locker ready)
- Support for up to 500-GB SATA 3.0Gb/s Smart IV hard drives
- Value-added software on select models
 - HP Support Assistant
 - HP Software Agent
 - McAfee Anti-Virus with 60 day Live Update Subscription
 - HP Vision Diagnostics software
 - Microsoft Office 2007
 - PDF Complete
 - Computrace Enabler for Desktops (select countries)
 - HP System Software manager
 - HP Power Manager
 - Firefox- HP Virtual Browser
- Value-added software available for free download from the Web (<http://www.hp.com/go/easydeploy>)
 - HP Client Automation – Starter Edition
 - HP SoftPaq Download Manager
 - HP System Software Manager
 - HP Client Catalog for Microsoft SMS
- Fully compatible software OS image across all models (Microtower, Small Form Factor)
- HP BIOS for security, manageability and software image stability
- Protected by HP Services, including standard warranties up to 5-5-5 (terms and conditions vary by country; certain restrictions and exclusions apply)
- Selected configurations with global availability easily set up and ordered through HP.com Business to Business portals (<http://h10019.www1.hp.com/business-site/index.html>)
- Tailored HP Factory Express deployment and lifecycle services available (<http://h71028.www7.hp.com/enterprise/cache/97688-0-0-225-121.aspx>)

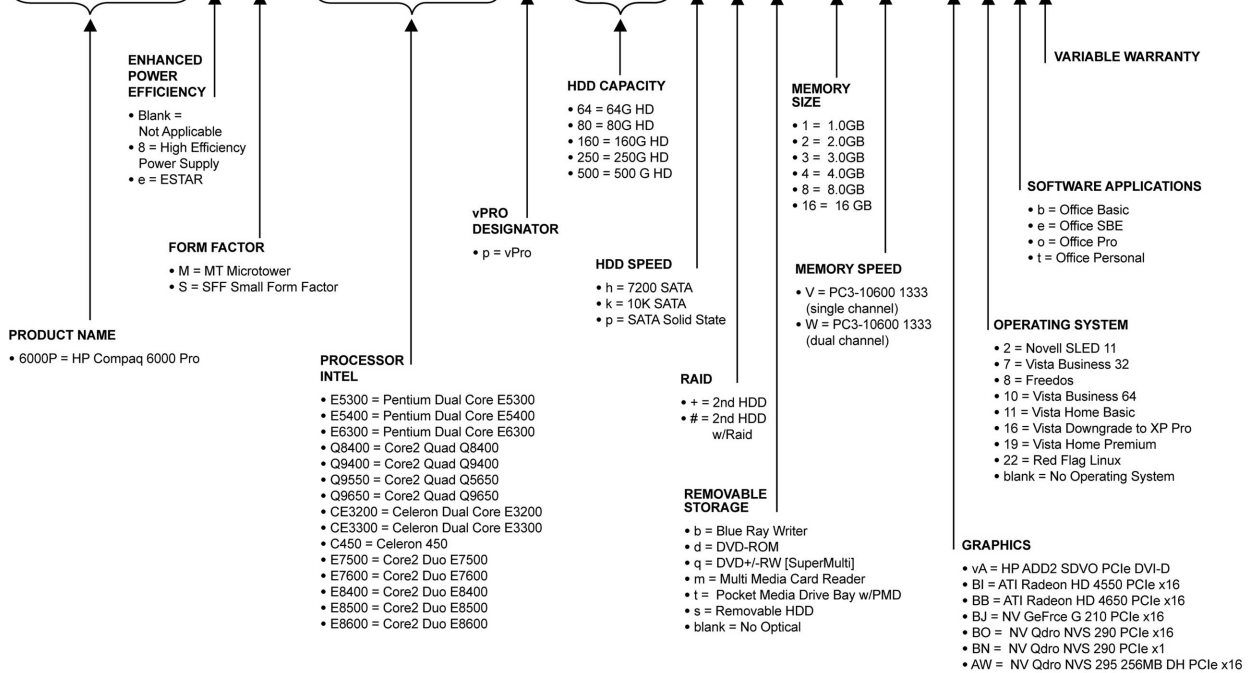
*TPM module disabled where use is restricted by law; for example, Russia.

Configurable Components - Select Models (localized by Regions)

Model Key and Example

NOTE: This diagram is an example that illustrates how to read the model number. It is not intended to give every available configuration choice specified in the body of this document and may include references to features that are out of date and no longer available. Because the configurations offered vary by region, some features listed may not be available in all countries.

6000PeM/Q9650p/250h+b/8W/v7tf



Standard Features and Configurable Components (availability may vary by country)

Operating System -
One of the following

Preinstalled

Genuine Windows 7 Professional Edition 32*
Genuine Windows 7 Professional Edition 64*
Windows XP Professional (available through downgrade rights from Genuine Windows 7 Professional)**
Genuine Windows 7 Home Premium Edition 32*
Genuine Windows 7 Home Premium Edition 64*
Genuine Windows 7 Home Basic Edition 32*
Windows XP Professional (available through downgrade rights from Genuine Windows Vista Business)****
Novell SUSE Linux Enterprise Desktop 11 †
FreeDOS

Supported

Genuine Windows 7 Enterprise Edition (32-bit)**
Genuine Windows 7 Enterprise Edition (64-bit)**
Genuine Windows Vista Business 64**
Genuine Windows Vista Enterprise 32**
Genuine Windows Vista Enterprise 64**
Genuine Windows Vista Business 32**
Genuine Windows Vista Home Basic 32**

Certified

Novell SUSE Linux Enterprise Desktop 11 †
Red Hat Enterprise Linux 64 ††

NOTE: Windows XP Mode, available as a separate download for Windows 7 Professional, works with virtualization software such as Windows Virtual PC to run older Windows XP business software on the Windows 7 desktop.

* Not available in all countries. Offered when Windows 7 is generally available. System may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality.
See <http://www.microsoft.com/windows/windows-7/> for details.

** Certain Windows Vista product features require advanced or additional hardware. See: <http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx> and: <http://www.microsoft.com/windowsvista/getready/capable.mspx> for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: <http://www.windowsvista.com/upgradeadvisor>.

+ Windows 7 Professional disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order annually at least 25 customer systems with the same custom image.

++ Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order annually at least 25 customer systems with the same custom image.

† The following features are not supported by Novell SUSE Linux Enterprise Desktop:

- HP 22-in-1 Media Card Reader with PCI Card
- DisplayPort
- HP ProtectTools

Standard Features and Configurable Components (availability may vary by country)

- SATA Blu-ray Writer playback of commercial movies
- Intel Gigabit CT Desktop NIC
- Broadcom NetXtreme Gigabit Ethernet PCIe NIC Plus Card
- HP ADD2 SDVO PCIe DVI-D adapter
- 2nd serial port adapter (including low profile)
- Power Management features (US ENERGY STAR)

†† The following features are not supported by Red Hat Enterprise Linux 64:

- HP 22-in-1 Media Card Reader with PCI Card
- Integrated 1.2 TPM Embedded Security Chip
- Intel Gigabit CT Desktop NIC
- Broadcom NetXtreme Gigabit Ethernet PCIe NIC Plus Card (DASH functionality)
- LSI PCEe x1 Hi-Speed 56K International SoftModem
- HP ADD2 SDVO PCIe DVI-D adapter
- HP FireWire / IEEE 1394 PCI Card (full height and low profile)
- 2nd serial port adapter (including low profile)
- HP Wireless 802.11b/g/n PCIe x1 Card
- HP USB Smartcard Keyboard
- Power Management features (US ENERGY STAR)
- SATA Blu-ray Writer
- Broadcom NetXtreme Gigabit Ethernet Plus (DASH 1.1) PCIe NIC Card
- ATI Radeon HD 4550 Dual Head PCIe x16 Graphics Card
- ATI Radeon HD 4650 (1 GB DH) PCIe x16 Graphics Card
- NVIDIA GeForce 310 DP PCIe x16 Graphics Card
- NVIDIA Quadro NVS 290 (256MB DH) PCIe x16 Graphics Card
- NVIDIA Quadro NVS 290 PCIe x1 Graphics Card
- NVIDIA Quadro NVS 295 (256MB DH) PCIe x16 Graphics Card

Value-added Software (on select models; not included with FreeDOS)

HP Software Agent	Microsoft Office 2007 Basic
HP Support Assistant	Microsoft Office 2007 Personal
HP Systems Software Manager	Microsoft Office 2007 Professional
HP Vision Diagnostics	Microsoft Office 2007 Small Business Edition
HP Power Manager	DASH 1.1 Manageability*
McAfee Total Protection Anti-Virus with 60 day trial Subscription	Computrace Enabler for Desktops (select countries)**
Roxio Creator Business (select models)	SRS Premium Sound Software for HP Thin USB Powered Speakers (select models)
Firefox-HP Virtual Browser	Corel WinDVD (select models)

* Requires Broadcom NetXtreme Gigabit Ethernet Plus (DASH 1.1) PCIe NIC

** Requires HP LoJack Pro for ProtectTools for full functionality. Tracking and tracing subscription sold separately.

Standard Features and Configurable Components (availability may vary by country)

Value-added Software (available for free download from the Web http://www.hp.com/go/easydeploy)	HP Client Automation – Starter Edition	HP Client Catalog for Microsoft SMS
	HP Client Manager from Symantec	HP Systems Software Manager
	HP SoftPaq Download Manager	HP Disk Sanitizer, External Edition
Value-added Services and Features	HP Stable Platform Program	Factory Express Deployment and Lifecycle Services
	Business-to-Business Portals	TPM 1.2 Security chip*
	HP Global Series Services	

* TPM module disabled where use is restricted by law; for example, Russia.

Service and Support On-site Warranty and Service ^{Note 1}: This limited warranty and service offering delivers parts, labour and on-site repair for terms up to 5 years. Response time is next business-day ^{Note 2} and includes free telephone support ^{Note 3} 24 x 7. Global coverage ^{Note 2} ensures that any product purchased in one country and transferred to another non-restricted country will remain fully covered under the original warranty and service offering. Some countries/regions do not offer one year onsite and labour. For HP Care Pack services see: <http://www.hp.com/go/lookuptool>.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

	Microtower	Small Form Factor
Chassis Dimensions (H x W x D)	14.85 x 6.95 x 16.96 in 377.2 x 176.5 x 430.8 mm	3.95 x 13.30 x 14.90 in 100.3 x 337.8 x 378.5
Optional Tower Stand Dimensions (H x W x D)	N/A	1.05 x 6.95 x 7.83 in (26.75 x 176.46 x 198.87 mm)
System weight*	20.5 lb (9.3 kg)	16.0 lb (7.26 kg)
System volume	1739 cu in	782.77 cu in (12.8 liters)
Shipping weight*	28.79 lb (13.06 kg)	26.70 lb (12.11 kg)
Maximum supported weight (desktop orientation)	N/A	77.1 lb (35 kg)
Shipping box dimensions (H x W x D)	19.69 x 12.2 x 23.62 in 500 x 310 x 600 mm	9.72 x 19.68 x 22.67 in 246.9 x 499.9 x 575.8 mm
<i>* Configured with 1 hard drive, 1 optical drive, no diskette drive, and no PCI card.</i>		
Power Supply	320W power supply – active PFC	240W power supply – active PFC
Energy Efficient Power Supply	320W 89% efficient power supply – active PFC	240W 89% efficient power supply – active PFC

Standard Features and Configurable Components (availability may vary by country)

Ports	
USB 2.0	10 (4 front, 6 rear)
Serial	1 standard with 2 nd optional
Parallel	1 optional
PS/2	1 keyboard, 1 mouse
Video	analog for integrated graphics
DVI output	available via HP DisplayPort to DVI-D Adapter
Support for Multi-Monitor	1 Standard DisplayPort and 1 Standard VGA
Audio	Integrated High Definition audio with internal speaker Front – mic and headphone Rear – input (supports microphone or line input), line out
NIC (RJ-45)	Integrated Intel 82567LM Gigabit Network Connection Ethernet

		MT	SFF
Chipset	Intel Q43 Express chipset	X	X

Processor and Speed*	Intel Celeron Dual-Core Processors:		
One of the following	Intel Celeron E3200 Processor (2.4-GHz, 2 MB L2 cache, 800-MHz FSB)	X	X
	Intel Celeron E3300 Processor (2.5-GHz, 2 MB L2 cache, 800-MHz FSB)	X	X
	Intel Pentium Dual-Core Processors:		
	Intel Pentium dual-core E5300 Processor (2.6-GHz, 2MB L2 cache, 800-MHz FSB)	X	X
	Intel Pentium dual-core E5400 Processor (2.70-GHz, 2MB L2 cache, 800-MHz FSB)	X	X
	Intel Pentium dual-core E6300 Processor (2.80-GHz, 2MB L2 cache, 800-MHz FSB)	X	X
	Intel Core 2 Duo Processors:		
	Intel Core 2 Duo E7500 Processor (2.93-GHz, 3 MB L2 cache, 1066-MHz FSB)	X	X
	Intel Core 2 Duo E7600 Processor (3.06-GHz, 3 MB L2 cache, 1066-MHz FSB)	X	X
	Intel Core 2 Duo E8400 Processor (3.0-GHz, 6 MB L2 cache, 1333-MHz FSB)	X	X
	Intel Core 2 Duo E8500 Processor (3.16-GHz, 6 MB L2 cache, 1333-MHz FSB)	X	X
	Intel Core 2 Duo E8600 Processor (3.33-GHz, 6 MB L2 cache, 1333-MHz FSB)	X	X
	Intel Core 2 Quad Processors:		
	Intel Core 2 Quad Q8400 Processor (2.66-GHz, 4 MB L2 cache, 1333-MHz FSB)	X	X
	Intel Core 2 Quad Q9400 Processor (2.66-GHz, 6 MB L2 cache, 1333-MHz FSB)	X	X
	Intel Core 2 Quad Q9550 Processor (2.83-GHz, 12 MB L2 cache, 1333-MHz FSB)	X	X
	Intel Core 2 Quad Q9650 Processor (3.0-GHz, 12 MB L2 cache, 1333-MHz FSB)	X	X

* Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families.

Standard Features and Configurable Components (availability may vary by country)

Memory

Supports un-buffered non-ECC DDR3 SDRAM

The Intel Q43 Express chipset supports un-buffered non-ECC DDR3 SDRAM (synchronous dynamic random access memory) of up to 16GB total memory, and at a frequency of up to 1066MHz.

NOTE: 1066MHz system memory frequency of operation requires at least PC3-8500 (DDR3-1066) memory type for all populated memory modules, and an Intel processor with FSB (front side bus) of at least 1066MHz.

NOTE: The Q43 chipset Graphics Memory Controller Hub (GMCH) supports DDR3 memory technology up to a maximum of 1066 MHz. Therefore, systems configured with PC3-10600 (1333 MHz) memory DIMMs will operate at 1066 MHz.

System Memory upgrades are accomplished by adding DDR3 SDRAM module(s) to empty DIMM slots on the System Board.

CAUTION: Voltage is supplied to the memory modules whenever the computer is connected to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board. The computer must be shut down with the AC power removed (disconnect AC power cord at rear chassis or at AC outlet) prior to adding or removing SDRAM modules.

HP recommends dual-channel symmetric configurations for the best memory performance. For best performance, add the same amount of total memory to each channel and do not inter-mix memory module speeds. For dual-channel symmetric performance, the total amount of memory in each channel must be equal. If memory module speeds are inter-mixed, the memory operating frequency will default to the slowest speed.

Microtower and Small Form Factor

Maximum Memory*

Supports up to 16GB of un-buffered non-ECC DDR3 SDRAM.

Slot 1 is black and must always be populated. Not all possible memory configurations are represented in the table below.

NOTE: For systems configured with more than 3GB of memory and a 32-bit operating system, all memory may not be available to the OS due to system resource requirements. Addressing memory above 4GB requires a 64-bit operating system.

Standard Features and Configurable Components (availability may vary by country)

Total Memory	DIMM Slot Population			
	Channel A		Channel B	
	1 (black)	2 (white)	3 (white)	4 (white)
1-GB (Single Channel)	1GB			
2-GB (Dual Channel Symmetric)	1GB		1GB	
3-GB (Dual Channel Asymmetric)	2GB		1GB	
4-GB (Dual Channel Symmetric)	2GB		2GB	
4-GB (Dual Channel Symmetric)	1GB	1GB	1GB	1GB
8-GB (Dual Channel Symmetric)	2GB	2GB	2GB	2GB
16-GB maximum (Dual Channel Symmetric)	4GB	4GB	4GB	4GB

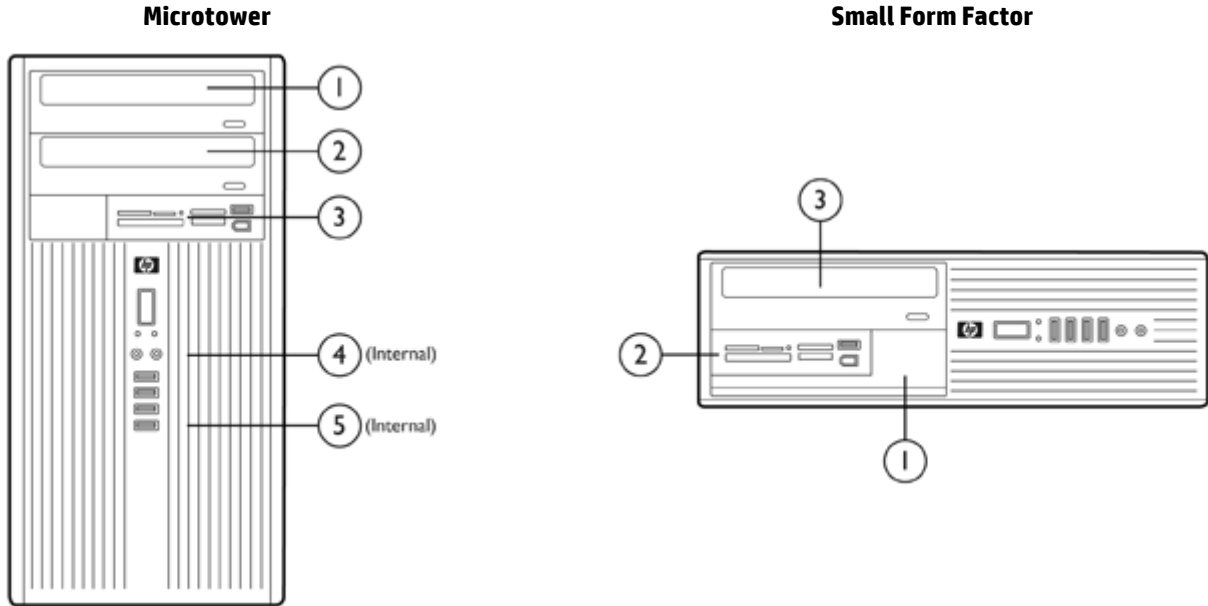
* The Intel Q43 Express chipset includes an integrated Management Engine (ME) micro-controller, which requires system memory to support manageability functions. If the system memory configuration is single-channel or dual-channel asymmetric, 16MB of system memory is pre-allocated for the ME at system startup. If the memory configuration is dual-channel symmetric, 32 MB of memory is pre-allocated for the ME at system startup. This pre-allocated memory is not available to the operating system, just as pre-allocated video memory is not available.

Expandability	Microtower	Small Form Factor
5-volt PCI slots	1 full-height	1 low-profile
Max power per slot	35W	35W
PCIe x1 slot	2	2
Max power per slot	10W	10W
PCIe x16 slot (also functions as SDVO/ADD2 slot)	1 full-height	1 low-profile
Max power per slot	75W	35W
External Bays		
3.5"	1	1
5.25"	2	1
IDE		
Internal 3.5" HDD Bays	2	1
Hard Drive Controller (SATA) Supported	SATA	SATA
Hard Drive Interfaces Supported	SATA 3.0Gb/s	SATA 3.0Gb/s

QuickSpecs

HP Compaq 6000 Pro Business PC

Standard Features and Configurable Components (availability may vary by country)



Storage – Drive Support

	Microtower			Small Form Factor		
	Media Card Reader or Pocket Media Drive (optional)	5.25" Serial ATA Devices	3.5" Serial ATA Devices	Media Card Reader or Pocket Media Drive (optional)	5.25" Serial ATA Devices	3.5" Serial ATA Devices
Quantity Supported	1	2	2	1	1	2
Position Supported	③	①, ②	③, ④, ⑤	②	①	②, ③
Controller	USB/Diskette	SATA	SATA	USB/Diskette	SATA	SATA

NOTE: The SATA port labeled SATA3 on the system board can be enabled by the BIOS as an eSATA port. Using it for an eSATA drive will require a separately purchased cable with an eSATA connector.

Standard Features and Configurable Components (availability may vary by country)

		MT	SFF
Hard Drive One or two of the following	250-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 RPM, NCQ, Smart IV)	X	X
	500-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 7200 RPM, NCQ, Smart IV)	X	X
	80-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 10,000 RPM, NCQ, Smart III)	X	X
	3.5" Removable 250-GB SATA 3.0 Gb/s Hard Drive (8MB Cache, 7200 RPM, NCQ, Smart IV)	X	X
	3.5" Removable 500-GB SATA 3.0 Gb/s Hard Drive (8MB Cache, 7200 RPM, NCQ, Smart IV)	X	X
	2 nd hard drive, 250-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 RPM, NCQ, Smart IV)	X	X
	2 nd hard drive, 500-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 7200 RPM, NCQ, Smart IV)	X	X
	2 nd hard drive, 80-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 10,000 RPM, NCQ, Smart III)	X	X
NOTE: NCQ functionality requires a user set-up BIOS setting.			
<hr/>			
Solid State Drive	64-GB Solid State Drive	X	X
<hr/>			
Removable Storage - One or more of the following depending on form factor (see Storage - Drive Support section above)	Pocket Media Drive 250GB Pocket Media Drive	X	X
	Media Reader HP 22-in-1 Media Card Reader (USB connection on the system board)	X	X
	HP 22-in1 (with 1394) Media Card Reader (USB connection on the system board)	X	X
	Optical Drives SATA DVD-ROM Drive	X	X
	SATA SuperMulti DVD Writer Drive	X	X
	SATA Blu-ray Writer	X	X
	<hr/>		
Security	TPM 1.2 Embedded Security Chip*	X	X
	HP Desktop Security lock kit (lock and cable)	X	X
	Security cable with Kensington lock	X	X
	HP Chassis Security Kit	X	X
	Optional HP ProtectTools 5.0 security software suite	X	X
	Optional LoJack Pro tracking and tracing subscription	X	X
	Optional USB Port Disable at factory (user configurable via BIOS)	X	X
* TPM module disabled where use is restricted by law; for example, Russia.			

Standard Features and Configurable Components (availability may vary by country)

NIC	Intel 82567LM Gigabit Network Connection (integrated on system board)	X	X
	Broadcom NetXtreme Gigabit Ethernet Plus PCIe NIC	X	X
	Broadcom NetXtreme Gigabit Ethernet Plus (DASH 1.1) PCIe NIC Card (with cable for internal USB header)	X	X
	Intel Gigabit CT Desktop NIC	X	X
Wireless	HP 802.11 b/g/n Wireless PCIe x1 card (full height bracket)	X	
	HP 802.11 b/g/n Wireless PCIe x1 card (low profile bracket)		X
Modem	LSI PCIe x1 56K International SoftModem	X	X
Graphics	Integrated Intel Graphics Media Accelerator 4500	X	X
	ATI Radeon HD 4650 (1 GB DH) PCIe x16 Graphics Card	X	
	ATI Radeon HD 4550 Dual Head PCIe x16 Graphics Card	X	X
	NVIDIA Quadro NVS 290 PCIe x1 Graphics Card	X	X
	NVIDIA Quadro NVS 290 (256MB DH) PCIe x16 Graphics Card	X	X
	NVIDIA Quadro NVS 295 (256MB DH) PCIe x16 Graphics Card*	X	X
	NVIDIA NVS 300 PCIe x16 512MB Graphics Card	X	X
	NVIDIA NVS 300 PCIe x1 512MB Graphics Card	X	X
	NVIDIA GeForce 310 DP PCIe x16 Graphics Card	X	X
	HP ADD2 SDVO PCIe DVI-D adapter	X	X
	HP DisplayPort to VGA Adapter	X	X
	HP DisplayPort to DVI-D Adapter	X	X
* When ordered with an Nvidia Quadro NVS 295 card, the PC is shipped with two DisplayPort to VGA Adapters. When an Nvidia Quadro NVS 295 card is purchased as an after-market option, it comes with two DisplayPort to DVI-D Adapters.			
Audio	Integrated High Definition audio with Realtek ALC261 codec (all ports are stereo)	X	X
	Microphone and Headphone front ports*	X	X
	Line-out and Line-In rear ports*	X	X
	Multistreaming capable*	X	X
	Internal Speaker	X	X
	HP Thin USB Powered Speakers (optional)	X	X
* Re-taskable ports; see technical specifications page 21.			

Standard Features and Configurable Components (availability may vary by country)

Input Devices

Keyboard - One of the following

HP PS/2 Standard Keyboard	X	X
HP USB Standard Keyboard	X	X
HP Smartcard Keyboard	X	X
HP USB PS/2 Washable Keyboard	X	X
HP USB Mini Keyboard	X	X

Mouse - One of the following

USB 2-Button Laser Mouse	X	X
PS/2 2-Button Optical Scroll Mouse	X	X
USB 2-Button Optical Scroll Mouse	X	X

Miscellaneous

2 nd serial port adapter	X	
2 nd serial port adapter (low profile)		X
Parallel port adapter	X	X
HP FireWire / IEEE 1394 Adapter	X	X
Tower stand		X

After-Market Options (availability may vary by region)

		MT	SFF	Part Number
Communications	Wireless LAN			
	HP 802.11 b/g/n Wireless PCIe x1 card	X	X	FH971AA
	NICs			
	Broadcom NetXtreme Gigabit Ethernet Plus (DASH 1.1) PCIe NIC (with cable for internal USB header)	X	X	EA833AA
	Intel Gigabit CT Desktop NIC	X	X	FH969AA
	Modem			
	LSI PCIe x1 56K International SoftModem	X	X	FH970AA
<hr/>				
Graphics	Single head solutions			
	HP ADD2 SDVO PCIe DVI-D Adapter	X	X	DY674AA
	Multi head solutions			
	ATI Radeon HD 4550 (256MB DH) PCIe x16 Card	X	X	AT042AA
	ATI Radeon HD 4650 (1 GB DH) PCIe x16 Graphics Card	X		VN566AA
	HP DisplayPort to VGA Adapter	X	X	AS615AA
	HP DisplayPort to DVI-D Adapter	X	X	FH973AA
	NVIDIA Quadro NVS 290 (256MB DH) PCIe x1 Graphics Card	X	X	KN586AA
	NVIDIA Quadro NVS 290 (256MB DH) PCIe x16 Graphics Card	X	X	KG748AA
	NVIDIA Quadro NVS 295 (256MB DH) PCIe x16 Graphics Card	X	X	FY943AA
	NVIDIA NVS 300 PCIe x16 512MB Graphics Card	X	X	BV456AA
	NVIDIA NVS 300 PCIe x1 512MB Graphics Card	X	X	BV457AA
NVIDIA GeForce 310 DP PCIe x16 Graphics Card	X	X	VG885AA	
<hr/>				
Hard Drives	Serial ATA Hard Drives			
	HP 250-GB SATA 3.0-Gb/s 7200 rpm Hard Drive	X	X	PY278AA
	HP 500-GB SATA 3.0-Gb/s 7200 rpm Hard Drive	X	X	KW347AA
	HP 80-GB SATA 3.0-Gb/s 10,000 rpm Hard Drive	X	X	EM172AA
	HP Removable SATA Hard Drive Enclosure (Frame & Carrier)	X	X	RY102AA
	HP Removable SATA Hard Drive Enclosure (Carrier Only)	X	X	RY103AA

After-Market Options (availability may vary by region)

Input/Output Devices	HP PS/2 Standard Keyboard	X	X	DT527A
	HP USB Standard Keyboard	X	X	DT528A
	HP USB Smartcard Keyboard	X	X	ED707AA
	HP USB Gray Standard Keyboard	X	X	DT529A
	HP USB PS/2 Washable Keyboard	X	X	VF097AA
	HP USB Mini Keyboard	X	X	AS601AA
	HP 2.4 GHz Wireless Keyboard and Mouse	X	X	NB896AA
	HP USB Laser Mouse	X	X	GW405AA
	HP PS/2 2-Button Optical Scroll Mouse	X	X	EY703AA
	HP USB 2-Button Optical Scroll Mouse	X	X	DC172B
Memory (DIMMs)	PC3-10600 (DDR3, 1333MHz) DIMMs Non-ECC			
	HP 4-GB PC3-10600 (DDR3 1333 MHz) DIMM	X	X	VH638AA
	HP 2-GB PC3-10600 (DDR3 1333MHz) DIMM	X	X	AT024AA
	HP 1-GB PC3-10600 (DDR3 1333 MHz) DIMM	X	X	AT023AA
Monitors	All HP monitors are supported that accept a graphics output provided by this PC. The LP3065 monitor can be supported by installing a graphics card that supports a dual-link DVI-D output.			
Multimedia	HP Thin USB Powered Speakers	X	X	KU901AV
Optical Drives	DVD-ROM Drive			
	HP SATA DVD-ROM Drive	X	X	AH047AA
	DVD Writer			
	SATA Blu-ray Writer	X	X	AR481AA
	HP SATA SuperMulti DVD Writer Drive	X	X	GF343AA
Removable Storage	Removable Drives			
	HP 250GB Pocket Media Drive	X	X	FE477AA
	Multimedia			
	HP 22-in-1 Media Card Reader	X	X	FX273AA
	HP 22-in-1 (with 1394) Media Card Reader	X	X	KN518AA

QuickSpecs

HP Compaq 6000 Pro Business PC

After-Market Options (availability may vary by region)

Security	Kensington lock	X	X	PC766A
	HP Business PC Security Lock	X	X	PV606AA
	HP Chassis Security Kit	X	X	AR639AA
	HP 2009 Wall Mount/Security Sleeve		X	TBD
Manageability	HP Client Configuration Manager, Premium Edition	X	X	T3488AA (use T3489AA for 1000 licenses)
	Broadcom NetXtreme Gigabit Ethernet Plus (DASH 1.1) PCIe NIC (with cable for internal USB header)	X	X	EA833AA
Brackets/Stand	HP 2009 Small Form Factor Tower Stand		X	VN569AA
Miscellaneous Accessories	HP Serial Port Adapter Kit	X	X	PA716A
	HP Parallel Port Adapter Kit	X	X	KD061AA
	HP FireWire / IEEE 1394 Adapter	X	X	PA997A



Technical Specifications

Unit Environment and Operating Conditions	Microtower	Small Form Factor
General Unit Operating Guidelines		
<ul style="list-style-type: none"> Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range. Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow. Never restrict airflow into the computer by blocking any vents or air intakes. Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air. Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow. If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply. 		
Temperature Range	Operating: 50° to 95° F (10° to 35° C)* Non-operating: -22° to 140° F(-30° to 60° C)	
Relative Humidity	Operating: 10% to 90% (non-condensing at ambient) Non-operating: 5% to 95% (non-condensing at ambient)	
Maximum Altitude (unpressurized)	Operating: 10,000 ft (3048 m) Non-operating: 30,000 ft (9144 m)	
* Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.		

	Microtower		Small Form Factor	
Power Supply	320-watt BTX power supply - Active PFC	320-watt 89% efficient* BTX power supply - Active PFC	240-watt BTX power supply - Active PFC	240-watt 89% efficient* BTX power supply - Active PFC
Operating Voltage Range	100-240VAC	100-240VAC	100-240VAC	100-240VAC
Rated Voltage Range	115V/230V	115V/230V	115V/230V	115V/230V
Rated Line Frequency	50/60 Hz	50/60 Hz	50/60 Hz	50/60 Hz
Operating Line Frequency Range	47-63 Hz	47-63 Hz	47-63 Hz	47-63 Hz
Rated Input Current	5.5A	5.5A	4A	4A
Power Supply Fan	Variable speed fan	Variable speed fan	Variable speed fan	Variable speed fan
Power Cord Length	6 ft (1.83 m)		6 ft (1.83 m)	
ENERGY STAR Compliant		X		X
FEMP Standby Power Compliant (<1W in S5 - Power Off)**	X	X	X	X
Power Consumption in ENERGY STAR Mode - Suspend to RAM (S3) (Instantly Available PC)	<4W	<3W	<4W	<3W

* Energy efficient power supply is a requirement for ENERGY STAR qualification in conjunction with a select range of processors and modules

** Power consumption in the Off/Apparent Off mode is measured and reported with the network interface controller "Wake on LAN" feature disabled in F10 Setup (default is "enabled").

Technical Specifications

ROM BIOS Information

Key features of the HP BIOS include:

- Deployment and manageability - HP BIOS provides several technologies that help integrate the HP Business desktop computer into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Stability - HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Security - HP BIOS offers a robust and flexible set of security features to help the system administrator secure their systems from removal of sensitive data, and help prevent access by unauthorized users. Ability to disable USB ports.
- Tracking and tracing capabilities in case of theft available in select countries (subscription sold separately).
- Thermal and power management - The HP BIOS provides and enables thermal and power management technologies to assist in operating the HP Business Desktop computer in any enterprise environment.
- Serviceability - HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery - HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (Flashlite), BIOS updates from within Windows (HPQFlash, SSM), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.

Additional HP BIOS Features

- Administrator password - Also known as the setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) - Represents a significant innovation in power and configuration management, allowing operating systems and applications to manage power based on activity and usage. Provides power conservation features under Windows XP.
- Mute internal speaker
- Disable USB ports

Other Features	Description
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI). <ul style="list-style-type: none">• Allows the system to wake from a low power mode.• Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
SMBIOS Ver. 2.6	System Management BIOS, previously known as DMI BIOS, for system management information
Wired for Management Support	Intel-driven, industry-wide initiative to make Intel architecture-based PCs, servers and mobile computers more inherently manageable right out of the box and over the network
Dual-State Power Button	Power button acts as both an on/off button and suspend-to-sleep button

Technical Specifications

Serviceability Features of System		
Dual Color Power LED on Front of Computer (Indicates Normal Operations and Fault Conditions)		
Diagnostic LED Explanation Table	Number of 1-second red LED blinks followed by 2-second pause, then repeats: 2-processor thermal protection activated 3-processor not installed 4-power supply failure 5-memory error 6-video error 7-PCA failure (ROM detected failure prior to video) 8-invalid ROM, bootblock recover mode	
<ul style="list-style-type: none"> System/Emergency ROM 	<ul style="list-style-type: none"> Flash ROM 	<ul style="list-style-type: none"> CMOS Battery Holder for easy Replacement
<ul style="list-style-type: none"> Flash Recovery with Video 	<ul style="list-style-type: none"> 5 Aux Power LED on System PCA 	<ul style="list-style-type: none"> Processor ZIF Socket for easy Upgrade
<ul style="list-style-type: none"> Over-Temp Warning on Screen (Requires IM Agents) 	<ul style="list-style-type: none"> Clear Password Jumper 	<ul style="list-style-type: none"> DIMM Connectors for easy Upgrade
<ul style="list-style-type: none"> Restore CD 	<ul style="list-style-type: none"> Clear CMOS Switch 	<ul style="list-style-type: none"> NIC LEDs (integrated) (Green & Amber)

Serviceability Features of Chassis		
<ul style="list-style-type: none"> Dual Colour Power and HD LED – To Indicate Normal Operations and Fault Conditions 	<ul style="list-style-type: none"> Colour coordinated cables and connectors 	<ul style="list-style-type: none"> Tool-less Hood Removal (thumbscrews for Microtower, spring-loaded latch for Small Form Factor)
<ul style="list-style-type: none"> Front power switch 	<ul style="list-style-type: none"> System memory can be upgraded on Microtower without removing any internal components 	<ul style="list-style-type: none"> Tool-less Hard Drive, CD & Diskette Removal

Additional Features	Description
Towerable	Small Form Factor can be oriented as a tower (in addition to desktop orientation)
Drive Self Tests (DPS)	<ul style="list-style-type: none"> Drive Protection System A diagnostic hard drive self test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user. Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced.
DPS Access through F10 Setup during Boot	<ul style="list-style-type: none"> The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures.
SMART IV Technology* (Self-Monitoring, Analysis and Reporting Technology)	<p>Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted</p> <ul style="list-style-type: none"> Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure
Intel® Standard Manageability	<p>All models feature Intel Standard Manageability technology including the following*:</p> <ul style="list-style-type: none"> Supports industry standards including DASH 1.1 and WSMAN

Technical Specifications

- Enables IT to manage and secure PCs even if they are off or the OS is inoperable.
- Remotely manage power states, boot to a diagnostic image, edit the PC BIOS, and inventory software and hardware.
- Hardware-level filtering can automatically remove an infected PC from the network while still keeping a connection to the management console for remote remediation.

* PCs with Intel Standard Manageability include features of Intel Active Management Technology (Intel AMT). Intel AMT requires the computer system to have an Intel AMT-enabled chipset, network hardware and software, as well as connection with a power source and a corporate network connection. Setup requires configuration by the purchaser and may require scripting with the management console or further integration into existing security frameworks to enable certain functionality. For more information, see www.intel.com/technology/platform-technology/intel-amt/.

DASH 1.1 support (Desktop and Mobile Architecture for System Hardware)

A standards initiative for representing out-of-band management capability for computer systems. It is a secure, web-services based successor to ASF.

ASF 2.0 support (Alert Standard Format)

Industry-standard specification for network alerting in operating system-absent environments

Technical Specifications - Audio

High Definition Audio	Type	Integrated
	High Definition Stereo Codec	Yes - 2-channel Realtek ALC261 codec
	Audio Jacks	Front microphone-In (150-K ohm Input Impedance) Rear Line-In/Microphone input (150-K ohm Input Impedance, function is configurable by audio driver) Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm load) Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load)

NOTES:

Internal Speaker Amplifier is for Internal Speaker only. External Speakers need to be powered externally.

The rear input port can function as a Line-In or Microphone-In jack.

The front Microphone jack is retaskable to support headphones. When functioning as a headphone jack the same audio stream will be sent to both front jacks.

The front Microphone jack is also retaskable to function as a Line-in jack.

The Realtek Control Panel software required to reassign audio ports is preloaded but must be installed by the customer before these functions can be performed.

Multistreaming Capable	Multistreaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks.
Sampling	8 kHz - 192 kHz
Wavetable Syntheses (software)	Yes - Uses OS soft wavetable
Analog Audio	Yes
Number of Channels on Line-Out (mono/stereo)	Stereo (Left & Right channels)
Internal Audio Speaker Power Rating	1.5 W
Internal Speaker	Yes; ability to mute internal speaker through F10 Setup
External Speaker Jack (Line-Out)	Yes

Technical Specifications - Communications

Integrated Intel 82567LM Gigabit Network Connection	Connector	RJ-45
	Controller	Intel 82567LM Gigabit platform LAN Connect Networking Controller
	Memory	Integrated 96KbB on chip buffer memory
	Data rates supported	10/100/1000 Mbps
	Compliance	IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3 ab and 802.3u compliant
	Bus architecture	GLCI, LCI interface. Intel specific MAC to PHY interface
	Data transfer mode	At gigabit GLCI (802.3 serdes) is for Data, LCI (parallel bus)for MDIO, at 10/100 LCI for both data and MDIO, GLCI is idle.
	Power requirement	Require 3.3Vaux, 1.8V and 1.0V or just 3.3V with integrated regulators Power consumption 1.16 Watts for 82566, whole LOM 2.53 Watts
	Boot ROM support	Yes
	Network transfer mode	Full-duplex Half-duplex (not available for the 1000BASE-T transceiver)
	Network transfer rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Environmental	Operating temperature 32° to 131°F (0° to 55° C) To 70° C for external regulator Operating humidity 85% at 131° F (55° C)
	Management capabilities	WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic.
Alerting	ASF 2.0 support, AMT 3.0 support	

Intel Gigabit CT Desktop NIC	Connector	RJ-45
	Controller	Intel WG82574L Gigabit Ethernet Controller
	Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers
	Data rates supported	10/100/1000 Mbps
	Compliance	IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x flow control
	Bus architecture	PCI-E 1.0a
	Data path width	X1, 250 MB/s, Bi-directional interface
	Data transfer mode	Bus-master DMA
	Hardware certifications	FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for European Union
	Power requirement	Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T
Boot ROM support	Yes	

Technical Specifications - Communications

Network transfer rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
Environmental	Operating temperature 32° to 131°F (0° to 55° C) Operating humidity 85% at 131° F (55° C)
Dimensions	4.75 x 2.25 x 0.8 in (12.1 x 5.7 x 2.0 cm)
Operating system driver support	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows XP Professional or Windows XP Home 32*. No driver is required for this device. Native support is provided by the operating system. Red Hat Linux 7.2, Linux 7.3 and Red Hat Enterprise Linux 3
	* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor . For Windows Vista system requirements, visit: http://www.windowsvista.com/systemrequirements .
Management capabilities	WOL , PXE, DMI, WFM 2.0

Broadcom NetXtreme Gigabit Ethernet Plus PCIe NIC Card	Connector	RJ-45
	Controller	Broadcom 5761 PCI-Express LAN Controller
	Memory	8 MB NVRAM serial Flash
	Data rates supported	10/100/1000 Mbps
	Compliance	IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x
	Bus architecture	PCI-E
	Data path width	Single channel, PCI-E
	Data transfer mode	Bus-master DMA
	Hardware certifications	FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI for Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed (E212044), European Union Notice (CE 0682)
	Power requirement	1.8W @ 3.3V
	Boot ROM support	Yes
	Network transfer mode	Full-duplex Half-duplex (not available for the 1000BASE-T transceiver)
	Network transfer rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)

Technical Specifications - Communications

Environmental	Operating temperature	32° to 131°F (0° to 55° C)
	Operating humidity	131° F (55° C) with 5% to 95% non-condensing humidity
Dimensions	2.75 in x 4.13 in (7 cm x 10.5 cm), low profile compatible	
Management capabilities	ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility, ASF2.0, DASH 1.0 and DASH 1.1 profiles	

HP 802.11b/g/n Wireless PCIe x1 Card	Dimensions (L x H)	3.3 x 4.7 inches (8.5 x 12 cm)		
	Weight	0.08 pounds (40 g)		
	Controller	Ralink RT2790		
	System interface	PCIExpress x1		
	Network standard	802.11 b/g/n		
	Frequency band	2.400 - 2.497 GHz		
	Operating temperature	14° to 149°F, operating (-10° to 65°C, operating)		
	Storage temperature	-40° to 176°F, non-operating (-40° to 80°C, non-operating)		
	Humidity	10-90% operating 5-95% non-operating		
	Operating voltage	3.3V +/- 9% 12V +/- 8%		
	Power consumption	Platform/WLAN Mode	Power Consumption	
		Maximum Power Consumption	10 Watts	
		Transmit Only	4 Watts maximum averaged power over 1 second	
		Transmit Packet or Active Scanning	1000 mA peak current for 100 microseconds or longer	
	Receive Only Mode or Idle without IEEE PSP mode enabled	3 Watts maximum averaged over 1 second		
	Idle, with IEEE PSP mode enabled	1.0 Watts maximum averaged over 1 second		
	Transmit Disabled (turned off in software)	50 mW maximum, averaged over 1 second		
	Platform in S3 or S4 (power removed from Low Profile PCI Express Card)	5 mW maximum, averaged over 1 second		
Output power (approximately)	802.11b modes	802.11g modes	EWC modes	
	+19 dBm +/- 1.0 dB maximum	+17 dBm +/- 1.0 dB maximum	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains)	
Receive sensitivity	Mode	Data rate	Sensitivity	
	802.11b	1 Mbps	-94 dBm	
	802.11b	11 Mbps	-85 dBm	

Technical Specifications - Communications

	802.11g	6 Mbps	-91 dBm
	802.11g	18 Mbps	-85 dBm
	802.11g	48 Mbps	-75 dBm
	802.11g	54 Mbps	-72 dBm
	EWC (2.4 GHz)	6.5 Mbps	-87 dBm
	EWC (2.4 GHz)	54 Mbps	-82 dBm
	EWC (2.4 GHz)	81 Mbps	-78 dBm
	EWC (2.4 GHz)	162 Mbps	-74 dBm
	EWC (2.4 GHz)	270 Mbps	-68 dBm
	EWC (2.4 GHz)	300 Mbps	-64 dBm
Data transfer rate	Data Rate (MCS)	Minimum Throughput	
	1 Mbps (802.11 b)	700 kbps	
	2 Mbps (802.11 b)	1.4 Mbps	
	5.5 Mbps (802.11 b)	3.5 Mbps	
	11 Mbps (802.11 b)	5.9 Mbps	
	12 Mbps (802.11 g)	6 Mbps	
	18 Mbps (802.11 g)	9 Mbps	
	24 Mbps (802.11 g)	12 Mbps	
	36 Mbps (802.11 g)	18 Mbps	
	48 Mbps (802.11 g)	21 Mbps	
	54 Mbps (802.11 g)	22.5 Mbps	
	6.5 Mbps (20 MHz EWC)	4.5 Mbps	
	13 Mbps (20 MHz EWC)	9 Mbps	
	19.5 Mbps (20 MHz EWC)	13.5 Mbps	
	26 Mbps (20 MHz EWC)	18 Mbps	
	39 Mbps (20 MHz EWC)	27 Mbps	
	52 Mbps (20 MHz EWC)	36 Mbps	
	58.5 Mbps (20 MHz EWC)	40 Mbps	
	65 Mbps (20 MHz EWC)	45 Mbps	
	78 Mbps (20 MHz EWC)	54 Mbps	
	104 Mbps (20 MHz EWC)	72 Mbps	
	117 Mbps (20 MHz EWC)	81 Mbps	
	130 Mbps (20 MHz EWC)	91 Mbps	
	13.5 Mbps (40 MHz EWC)	8 Mbps	
	27 Mbps (40 MHz EWC)	16 Mbps	
	40.5 Mbps (40 MHz EWC)	24 Mbps	
	54 Mbps (40 MHz EWC)	32 Mbps	
	81 Mbps (40 MHz EWC)	48 Mbps	
	108 Mbps (40 MHz EWC)	64 Mbps	
	121.5 Mbps (40 MHz EWC)	72 Mbps	
	135 Mbps (40 MHz EWC)	81 Mbps	

Technical Specifications - Communications

Security	<ul style="list-style-type: none"> • IEEE and WiFi compliant 64 / 128 bit WEP encryption • AES: CCM • 802.1x authentication • WPA: 802.1x. WPA-PSK and TKIP • WPA2 certification • IEEE 802.11i • Cisco Certified Extensions, all versions through V5
Antenna	HP part number 497792-001
Certifications	Wi-Fi certified
Certifications for use by country	United States, Canada, Peru, Taiwan

LSI PCIe x1 56K International SoftModem

Data Transmission	Technology speeds: 56,000 Kbps maximum downstream data, controllerless NOTE: 56 Kbps technology refers to download speeds only and requires compatible modems at server sites. Other conditions may limit modem speed. FCC limitations allow a maximum of 53 Kbps during download transmissions.
Data Speeds	(Upload only) 33,600/31,200/28,800/26,400/21,600/19,200/16,800/14,400/12,000/9,600/7,200/4,800/2,400/1,200/300
Data Standards	ITU-T V.90, ITU-T, ITU-T V.34, V.44, V.42, V.42bis21, V.32bis, Bell 212A, and Bell 103
Fax Speeds	14,400/12,000/9,600/7,200/4,800/2,400/1,200/300 b/s
Fax Mode Capabilities	ITU-T T.31 class 1 FAX, V. 17, V.29, V.27ter, and V.21 Channel 2
Error Correction and Data Compression	V.44, 42bis, V.42 and MNP2-5
Power Management	PCI Bus Power Management Interface Specification (PCI-PM) Revision 1.2, Appendix A. D0, D3hot, and D3cold. Wake on Ring state when in D3cold. If the power management event (PME) feature is enabled in D3cold, a modem can wake the system via WAKE# (WAKEN) or beacon. Meets PCI Express 1.1 standard.
Upgradeability	Driver upgradeable for future enhancements
Video	ITU-T V.80 video ready interface
Other	TIA/EIA 602 standard AT command set Integrated DTE interface with speeds of up to 115.2 Kbps, parallel 16550a UART-compatible interface Optional ring wakeup signal
Operating Temperature	32° to 158° F (0° to 70° C)
Operating Humidity	20% to 90%, non-condensing
Power	Requires a 3.3-V auxiliary power rail on PCI express bus Uses only one PCI express load (i.e., one grant/request pair), one shared IRQ, one electrical load
Chipset	LSI SV92EX - Integrated PCI interface with 3.3-V tolerant buffers and CardBus support
Dimensions (L X H)	Complies with PCI express low profile specifications-6.7 x 2.3 in (17.0 x 5.8 cm) and supports high- and low-profile brackets

Technical Specifications - Communications

Connection	Single RJ-11 connector
Other Features	Digital line protection, call progress monitoring via on-board piezo device, support for high profile and low profile brackets, PnP ID support
Safety	UL recognized to UL 1950, 3 rd edition (U.S. and Canada); IEC 950 (TUV, NEMKO, DEMKO, SEMKO); CE Mark, EC 950 (TUV, NEMKO, DEMKO, SEMKO, CE mark
EMC	FCC Part 15, IC ES003, EN 55022, 3 rd edition, EN 55024, annex A, EN 61000-4-6, EN 61000-4-8
Telecom	FCC Part 68, IC-CS-03 (Canada); Worldwide PTT approvals Not available in Korea or the Republic of South Africa.
Other	The SV92EX device is packaged in a 32-pin micro leadless chip carrier (MLCC). The SV92EX is fully compliant with the PCI Express revision 1.1 specification. WHQL approved; ASPM compliant.

Technical Specifications - Graphics

**Integrated Intel
Graphics Media
Accelerator 4500**

3D/2D Controller
VGA Controller
DisplayPort
Bus Type
RAMDAC
Memory

Microsoft DirectX® 10 based with support for Pixel Shader 3.0

Integrated

Integrated, Multimode capable; supports HDCP

PCI Express™ x16

Integrated, 350 MHz

Graphics memory is shared with system memory. Graphics memory usage varies depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio Video Playback) support for playback of protected video content. For Vista, use of PAVP heavy mode preallocates an additional 96MB.

Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

Windows XP Memory Usage:

Total System Memory	Pre-Allocated (MB)	DVMT (MB)
.5GB	32	128
1.0GB	32	512
1.5GB	32	768
2 GB & more	32	1024

Windows Vista Memory Usage:

(Assumes Management Engine , VT-d enabled and other memory allocated for other BIOS usage)

System Memory	PAVP	Avail System Memory (MB)	Total Avail GFX Memory (MB)	Dedicated Video Memory (MB)	System Video Memory (MB)	Shared System Memory (MB)
1 GB	Lite	952	252	32	96	124
	Heavy	856	294	122	6	166
2 GB	Lite	1976	764	32	96	636
	Heavy	1880	806	122	6	678
4 GB	Lite	4024	1759	32	96	1631
	Heavy	3928	1759	122	6	1631
6 GB	Lite	6072	1759	32	96	1631
	Heavy	5976	1759	122	6	1631
8 GB	Lite	8120	1759	32	96	1631
	Heavy	8024	1759	122	6	1631

Total Available GFX Memory: Total graphics memory available to the system as reported by the OS.

Technical Specifications - Graphics

Dedicated Video Memory: Memory owned and locked for graphics use as reported by the OS. (Preallocated)

System Video Memory: System memory locked and dedicated for graphics use.

Shared System Memory: Memory dynamically allocated for Graphics use

HW Video Decode Hardware Accelerated decode for MPEG2 encrypted video; support for PAVP Lite (default) and Heavy (or Paranoid) modes

Maximum Color Depth 32 bits/pixel

Maximum Vertical Refresh Rate 85 Hz at up to 1920x1440, 75 Hz at 2048x1536. Varies with mode and configuration. See table below.

Multi-display Support Dual monitor support facilitated via one VGA port and one DisplayPort integrated on the back plane of the system board and presented as part of the rear I/O set of interfaces. DVI supported via optional HP DisplayPort to DVI-D adapter.

Graphics/Video API Support Microsoft DirectX® 10, OpenGL® 1.5 (OpenGL® 2.0 available in a driver update)

Resolutions Supported

NOTE: Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP.

Resolution	Maximum Refresh Rate (Hz)	
	Analog Connection	Digital Connection
640x480	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x1024	85	60
1440x900	75	60
1600x1200	85	60
1680x1050	75	60
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	N/A
2048x1536	75	N/A
2560x1600	N/A	60*

* Only supported when using a DisplayPort connection

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections.

ATI Radeon HD 4650 (1 GB	Bus type	PCI Express (x16 lanes)
DH) PCIe x16 Graphics	Maximum vertical refresh rate	85 Hz
Card (FH Only)	Display support	Integrated 400 MHz RAMDAC
	Display max resolution	2560 x 1600 digital, 2048 x 1536 analog
	Board display options	Supports two displays through any combination of two of the three output ports.
	Board configuration	
	Specification	Description

Technical Specifications - Graphics

	Graphics Chip	RV730Pro
	Core clock	600 MHz
	Memory clock	500 MHz
	Frame buffer	1 GB DDR3, 128 bit wide
Maximum power	55 W	
Languages supported	24 languages: English, Arabic, Chinese Simplified, Chinese Traditional, Czechoslovakian, Danish, Dutch, Finnish, French, German, Greek, Hebrew, Hungarian, Italian, Japanese, Korean, Norwegian, Polish, Portuguese, Russian, Spanish, Swedish, Thai, Turkish	
Compliance standards	<p>EMC Emissions: a) CISPR22: 1997/EN 55022:1998 - Class B - Limits and methods of measurement of radio disturbance characteristics of Information Technology Equipment</p> <p>EMC Immunity: CISPR 24:1997/EN 55024:1998 - Information Technology Equipment - Immunity Characteristics - Limits and Methods of Measurement.</p>	

ATI Radeon HD 4650 (! GB) PCIe x16 Graphics Card display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

Resolution	Maximum Refresh Rate (Hz)	
	Analog Connection	Digital Connection
640x480	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x1024	85	60
1440x900	75	60
1600x1200	85	60
1680x1050	75	60
1920x1080	85	60-R*
1920x1200	85	60-R
1920x1440	85	N/A
2048x1536	75	N/A
2560x1600	N/A	60**

* Max HDMI resolution is 1080p

** Only supported when using a dual-link DVI connection

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections.

ATI Radeon HD 4550 (256 MB DH) PCIe x16 Graphics Card	Bus type	PCI Express (x16 lanes)
	Maximum vertical refresh rate	85 Hz
	Display support	Integrated 400 MHz RAMDAC
	Display max resolution	1900 x 1200 digital, 2048 x 1536 analog

Technical Specifications - Graphics

Board display options	Supports two displays via included DMS-59 to dual VGA cable or 2 DVI monitors via optional DMS-59 to dual DVI cable kit part number: DL139A. 4-pin mini-DIN S-video connector for TV output	
Board configuration	Specification	Description
	Graphics Chip	RV710
	Core clock	600MHz
	Memory clock	800 MHz
	Frame buffer	256 MB DDR2, 64 bit wide
Languages supported	24 languages: English, Arabic, Chinese Simplified, Chinese Traditional, Czechoslovakian, Danish, Dutch, Finnish, French, German, Greek, Hebrew, Hungarian, Italian, Japanese, Korean, Norwegian, Polish, Portuguese, Russian, Spanish, Swedish, Thai, Turkish	
Compliance standards	<u>EMC Emissions:</u> a) FCC Part 15, Subpart B - Unintentional Radiators, Class B Computing Devices for Home & Office Use b) CISPR22: 1997/EN 55022:1998 - Class B - Limits and methods of measurement of radio disturbance characteristics of Information Technology Equipment c) Canadian Standard ICES-003 is equivalent to CISPR22 d) Taiwanese Standard BSMI e) Japanese VCCI f) Australian C-Tick g) Korean (KCC)	
	<u>EMC Immunity:</u> CISPR 24:1997/EN 55024:1998 - Information Technology Equipment - Immunity Characteristics - Limits and Methods of Measurement.	

ATI Radeon HD 4550 DH PCIe x16 Graphics Card display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP.

Resolution	Maximum Refresh Rate (Hz)	
	Analog Connection	Digital Connection
640x480	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x1024	85	60
1440x900	75	60
1600x1200	85	60
1680x1050	75	60
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	N/A
2048x1536	75	N/A
2560x1600	N/A	N/A

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections.

Technical Specifications - Graphics

NVIDIA Quadro NVS 290 PCIe x1 Graphics Card	Bus type	PCIe x1 Low profile, both ATX and low profile brackets included		
	Graphics Controller	Integrated Quadro 290 2D graphics processor unit (GPU)		
	Memory	256 MB DDR2		
	Connector	Single high-density DMS-59 Flex Connector		
	Dimensions	Low-profile, 2.586 x 6.6 in (6.57 x 16.76 cm)		
	Multi-monitor support	Dual analog or digital (Single Link DVI) monitors (DVI support requires optional DVI cable kit DL139A)		
	RAMDAC	Dual 350 MHz (integrated)		
	Maximum pixel clock	350 MHz		
	Overlay planes	One 1-bit Video overlay plane		
	High-definition Video Processor (HDVP)	Full screen, full frame video playback of HDTV and DVD content DVD-ready motion compensation for MPEG-2 Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0) IDCT motion compensation 5-tap horizontal by 3-tap vertical filtering 8:1 up/down scaling		
	Input/Output connectors	DMS-59		
	Board display options	Supports two displays via included DMS-59 to dual VGA cable or 2 DVI monitors via optional DMS-59 to dual DVI-I single-link connectors cable kit part number: DL139A.		
	Board configuration	Specification	Description	
		Description	G86-825	
	Core clock	460 MHz		
	Memory clock	400 MHz		
	Frame buffer	256 MB DDR2, 64 bit wide		

NVIDIA Quadro NVS 290 PCIe x1 Graphics Card display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as they have not been tested and qualified by HP.

Technical Specifications - Graphics

Resolution	Maximum Refresh Rate (Hz)	
	Analog Connection	Digital Connection
640x480	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x1024	85	60
1440x900	75	60
1600x1200	85	60
1680x1050	75	60
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	N/A
2048x1536	75	N/A
2560x1600	N/A	N/A

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections.

NVIDIA Quadro NVS 290	Form Factor	Low Profile
256MB Dual Head PCIe x16 Graphics Card	Bus Type	PCIe x16
	Memory	256 MB 400MHz DDR2 SDRAM unified frame buffer, Z-buffer and Texture storage
	Connector	DMS-59, includes DMS-59 to Dual DVI-I cable. DMS-59 to Dual VGA cable available as an option.
	Display Resolution Support	Dual integrated analog display controllers supporting up to two analog displays at 2048x1536 @ 85Hz on both displays or dual digital displays at 1920x1200 (single-link). nVIEW advanced multi-display desktop and application management seamlessly integrated into Microsoft Windows
	RAMDAC	Integrated dual 400MHz
	Color planes	32-bit color buffer
	Overlay planes	Hardware supported
	nView architecture	Advanced multi-display desktop & application management seamlessly integrated into Microsoft Windows.
	Multi-Monitor support	Dual monitor support
	DVI support	DMS-59 (to dual DVI-SL)
	High-definition Video Processor (HDVP)	Full-screen, full-frame video playback of HDTV and DVD content DVD-ready motion compensation for MPEG-2 Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0) IDCT motion compensation 5-tap horizontal by 3-tap vertical filtering 8:1 up/down scaling
	Supported graphics APIs	OpenGL 2.1 & DX10 Support; Shader Model 4.0

Technical Specifications - Graphics

NVIDIA Quadro NVS 295 (256MB DH) PCIe x 16 Graphics Card	Form Factor	2.731 inches (H) × 6.600 inches (L), Half-Height	
	Graphics Controller	NVIDIA Quadro NVS 295 Graphics Board	
	Bus Type	PCI Express x16, Generation 2.0	
	Memory	256 MB GDDR3 SDRAM unified graphics memory	
	Connectors	2 DisplayPort Comes with 2 DisplayPort to VGA Adapters ('DisplayPort to DVI-D' and 'DisplayPort to DL DVI-D adapters available as an accessory)	
	Maximum Resolution	Two DisplayPort outputs drive two digital displays up to 2560 x 1600	
	Display Output	<ul style="list-style-type: none">• Drives DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking• Drives DVI enabled digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking (through DisplayPort to DVI-D (single link) cable)	
	Supported Graphics APIs	OpenGL 3.0 DirectX 10.0	

NVIDIA NVS 300 PCIe x16 512MB Graphics Card	Form Factor	PCI Express x16 (generation 2.0) Low Profile, half length, 2.3" x 6.6" Full height bracket utilized when configured to CMT or MT
	Graphics Controller	Nvidia GT218 GPU
	Memory Frame Buffer	512MB DDR3, 64-bit wide
	Output Connectors	Single DMS-59 connector Supports dual analog displays with included DMS-59 to dual VGA cable. Supports dual DVI displays with an optional DMS59 to dual DVI cable.
	Core Clock	520MHz
	Memory Clock	790MHz
	Supported Graphics APIs	OpenGL 3.3 support in hardware DirectX 10.0 support in hardware

Technical Specifications - Graphics

Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rate (Hz)	
	Analog	Digital
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A

NOTE: 60-R denotes reduced blanking timings are used on single link DVI connections and may be used with other digital connections.

NVIDIA NVS 300 PCIe x1 512MB Graphics Card

Form Factor	PCI Express x1 Low Profile, half length, 2.3" x 6.6" Full height bracket utilized when configured to CMT or MT
Graphics Controller	Nvidia GT218 GPU
Memory Frame Buffer	512MB DDR3, 64-bit wide
Output Connectors	Single DMS-59 connector Supports dual analog displays with included DMS-59 to dual VGA Y cable. Support dual digital displays with an optional adapters (see complete listing of available optional adapters elsewhere in this QuickSpec).
Core Clock	520MHz
Memory Clock	790MHz
Supported Graphics APIs	OpenGL 3.3 support in hardware DirectX 10.0 support in hardware

Technical Specifications - Graphics

Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rate (Hz)	
	Analog	Digital
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A

NOTE: 60-R denotes reduced blanking timings are used on single link DVI connections and may be used with other digital connections.

NVIDIA GeForce 310 DP PCIe x16 Graphics Card	Bus type	PCI Express (x16 lanes)
	Maximum vertical refresh rate	85 Hz
	Display support	Integrated 400 MHz RAMDAC
	Display max resolution	2560x1600 digital, 2048 x 1536 analog

NVIDIA GeForce 310 DP PCIe x16 Graphics Card display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP.

Resolution	Maximum Refresh Rate (Hz)	
	Analog Connection	Digital Connection
640x480	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x1024	85	60
1440x900	75	60
1600x1200	85	60
1680x1050	75	60
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	N/A
2048x1536	75	N/A
2560x1600	N/A	60*

Technical Specifications - Graphics

* Only supported when using a dual-link DVI or DP connection.

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections.

Board display options	Supports two displays via the DisplayPort and DVI connectors	
Board configuration	Specification	Description
	Graphics Chip	RV620
	Core clock	750 MHz
	Memory clock	500 MHz
	Frame buffer	512 MB DDR3, 64 bit wide
Audio Support (through HDMI only)	Integrated HD Audio codec supports linear PCM and Dolby® Digital (7.1) audio formats for HDMI output	
Operating systems support	Windows 7 Home Basic*, Windows 7 Home Premium*, Windows 7 Professional Edition 32*, Windows 7 Professional Edition 64*, Windows 7 Ultimate Edition 32*, Windows 7 Ultimate Edition 64*, Windows Vista Business 32†, Windows Vista Business 64†, Windows Vista Home Basic 32†, Windows Vista Home Basic 64†, Windows XP Professional or Windows XP Home 32†.	
	<p>*This system may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See: http://www.microsoft.com/windows/windows-7/ for details.</p> <p>Windows 7 Business disk may be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image</p> <p>† Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit: http://www.windowsvista.com/systemrequirements.</p> <p>Linux x86 and x86_64 distributions using XFree86 or X.Org‡.</p> <p>‡Linux drivers are available from ATI's website and may be available in a Linux distribution. Refer to the Open Source and Linux from HP website: http://www.hp.com/wwwolutions/linux/products/clients/ for support information.</p>	
Core power	22 W (max)	
Dimensions (H x D)	2.71 in x 6.60 in (68.90 mm x 167.65 mm)	
Weight	0.30 lb (134.3 g)	
Option kit contents	<ul style="list-style-type: none"> ● NVIDIA GeForce 310 DP PCIe x16 Graphics Card with full height bracket attached ● DVI to VGA adapter ● Software CD with graphics drivers ● Low profile bracket to convert the card for using in a low profile chassis ● Warranty documentation 	
Compliance standards	EMC Emissions: a) FCC Part 15, Subpart B - Unintentional Radiators, Class B Computing Devices for Home & Office Use	

Technical Specifications - Graphics

- b) CISPR22: 1997/EN 55022:1998 - Class B - Limits and methods of measurement of radio disturbance characteristics of Information Technology Equipment
- c) Canadian Standard ICES-003 is equivalent to CISPR22
- d) Taiwanese Standard BSMI
- e) Japanese VCCI
- f) Australian C-Tick
- g) Korean (MIC)

EMC Immunity:

CISPR 24:1997/EN 55024:1998 - Information Technology Equipment - Immunity Characteristics - Limits and Methods of Measurement.

HP ADD2 SDVO PCIe DVI-D Adapter	Models	HP ADD2 SDVO DVI-D Out Adapter
	Form Factor	Low-profile card
	DVI-D Connector	Digital connection only
	Dual Head Support	Yes, when used with the integrated VGA connector
	Display Devices Supported	HP L1740 HP L1940T HP L2045W HP LP1965

NOTE: These graphics adapters offer optimal performance with any display that meets applicable VESA standards.

Color Depth	All modes support 8-bpp, 16-bpp, and 24-bpp color depths
Host Interface Connector	Mechanically compliant with PCI-E standard Complies with the Intel ADD2 and Intel Serial Digital Video Output (SDVO) specifications
Dot Clock	165 MHz maximum
Display Modes	Supports display modes that require up to 165-MHz bandwidth on the link, as shown in the following table.

Resolution		60-Hz LCD	60-Hz	75-Hz	85-Hz
Blanking		5% reduced	GTF	GTF	GTF
640 x 480	VGA	Yes	Yes	Yes	Yes
800 x 600	SVGA	Yes	Yes	Yes	Yes
1024 x 768	XGA	Yes	Yes	Yes	Yes
1280 x 1024	SXGA	Yes	Yes	No	No
1600 x 1200	UXGA	Yes	Yes	No	No

HP DisplayPort to DVI-D Adapter	Connectors	DisplayPort and DVI-D single link connector
	Adapter length	7.5 in (19.0 cm)
	Adapter weight	.10 lbs (.05 kg)

Technical Specifications - Graphics

HP DisplayPort to VGA Adapter Connectors	DisplayPort and VGA connector
Adapter length	8 in (20 cm)
Adapter weight	.1 lbs (.06 kg)
Maximum vertical refresh rate	85 Hz
Display support	162 MHz RAMDAC
Display max resolution	1600x1200

HP DisplayPort to VGA adapter display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP. Using the HP DisplayPort to VGA Adapter may require an update to the graphics driver installed on your system. To install the most up-to-date graphics driver go to: www.hp.com.

Resolution	Max refresh rate
640x480	85
800x600	85
1024x768	85
1280x720	85
1280x1024	85
1440x900	75
1600x1200	60
1680x1050	60
1920x1080	60-R
1920x1200	60-R

NOTE: 60-R denotes reduced blanking timings are used. Not all monitors support reduced blanking timing.

Technical Specifications - Internal Storage

7200 RPM Serial ATA Hard Drives 500-GB

Capacity	500,107,862,016 bytes
Height	1 in (2.54 cm)
Width	Media diameter: 3.5 in (8.89 cm) Physical size: 4 in (10.2 cm)
Interface	Serial ATA (3.0 Gb/s)
Synchronous Transfer Rate (Maximum)	Up to 3 Gb/s
Buffer	16 MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 2.0 ms Average 11 ms Full-Stroke 21 ms
Rotational Speed	7,200 rpm
Logical Blocks	976,773,168
Operating Temperature	41° to 131° F (5° to 55° C)

250-GB

Capacity	250,059,350,016 bytes
Height	1 in (2.54 cm)
Width	Media diameter: 3.5 in (8.89 cm) Physical size: 4 in (10.2 cm)
Interface	Serial ATA (3.0 Gb/s)
Synchronous Transfer Rate (Maximum)	Up to 3 Gb/s
Buffer	8 MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 1.0 ms Average 8.5 ms Full-Stroke 18 ms
Rotational Speed	7,200 rpm
Logical Blocks	488,397,168
Operating Temperature	41° to 131° F (5° to 55° C)

Technical Specifications - Internal Storage

10,000 RPM Serial ATA Hard Drives	80-GB	Capacity	80,026,361,856 bytes
		Height	1 in (2.54 cm)
		Width	Media diameter: 2.5 in (? cm) Physical size: 4 in (10.2 cm)
		Interface	Serial ATA (1.5 Gb/s), Native Command Queuing enabled
		Synchronous Transfer Rate (Maximum)	Up to 3.0 Gb/s
		Cache	16 Mbytes
		Seek Time (typical reads, includes controller overhead, including settling)	Single Track 0.3 ms Average 4.6 ms Full-Stroke 10.2 ms
		Rotational Speed	10,000 rpm
		Logical Blocks	156,301,488
		Operating Temperature	41° to 131° F (5° to 55° C)

64 GB Solid State Drive	Capacity	64 GB	
	NAND Flash Memory	Multi Level Cell (MLC) with wear leveling controller	
	Interface type	SATA 3Gb/sec	
	Dimensions-external (W x H x D)	2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)	
	Weight	0.14 lb (65 g)	
	Internal transfer rate	Write speed	Up to 220 MB/s
		Read speed	Up to 120 MB/s
	Host transfer rate	Ultra DMA mode	Up to 150 MB/s
		DC power requirement	5 VDC 5%-100 mV ripple p-p
	Power	Total power consumption	<1.12Watt
		Environmental (all conditions, non-condensing)	Temperature (operating)
	Relative Humidity (operating)		5% to 95%
Maximum Wet Bulb Temperature (operating)	84° F (29° C)		
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, R1113 and C1172 Class B		

* For solid state disk drives, GB means 1 billion bytes. 16GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity varies by content and will be less than 15.8GB.

Technical Specifications - Input/Output Devices

USB Standard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
		Dimensions (L x W x H)	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)
		Weight	2 lb (0.9 kg) minimum
	Electrical	Operating voltage	+ 5VDC ± 5%
		Power consumption	50-mA maximum (with three LEDs ON)
		System interface	USB Type A plug connector
		ESD	CE level 4, 15-kV air discharge
		EMI - RFI	Conforms to FCC rules for a Class B computing device
	Mechanical	Microsoft® PC 99 - 2001	Functionally compliant
		Languages	38 available
		Keycaps	Low-profile design
		Switch actuation	55-g nominal peak force with tactile feedback
		Switch life	20 million keystrokes (using Hasco modified tester)
		Switch type	Contamination-resistant switch membrane
		Key-leveling mechanisms	For all double-wide and greater-length keys
		Cable length	6 ft (1.8 m)
		Microsoft PC 99 - 2001	Mechanically compliant
	Environmental	Acoustics	43-dBA maximum sound pressure level
		Operating temperature	50° to 122° F (10° to 50° C)
		Non-operating temperature	-22° to 140° F (-30° to 60° C)
		Operating humidity	10% to 90% (non-condensing at ambient)
		Non-operating humidity	20% to 80% (non-condensing at ambient)
		Operating shock	40 g, six surfaces
		Non-operating shock	80 g, six surfaces
		Operating vibration	2-g peak acceleration
		Non-operating vibration	4-g peak acceleration
		Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
		Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence
	Approvals		UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC
	Ergonomic compliance		ANSI HFS 100, ISO 9241-4, and TUVGS
	Kit contents		Keyboard, installation guide, warranty card, safety and comfort guide

Technical Specifications - Input/Output Devices

PS/2 Standard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
		Dimensions (L x W x H)	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)	
		Weight	2 lb (0.9 kg) minimum	
	Electrical	Operating voltage	+ 5VDC ± 5%	
		Power consumption	50-mA maximum (with three LEDs ON)	
		System interface	PS/2 6-pin mini din connector	
		ESD	CE level 4, 15-kV air discharge	
		EMI - RFI	Conforms to FCC rules for a Class B computing device	
		Mechanical	Microsoft PC 99 - 2001	Functionally compliant
			Languages	38 available
	Keycaps		Low-profile design	
	Switch actuation		55-g nominal peak force with tactile feedback	
	Switch life		20 million keystrokes (using Hasco modified tester)	
	Switch type		Contamination-resistant switch membrane	
	Key-leveling mechanisms		For all double-wide and greater-length keys	
	Cable length		6 ft (1.8 m)	
	Environmental		Microsoft PC 99 - 2001	Mechanically compliant
			Acoustics	43-dBA maximum sound pressure level
		Operating temperature	50° to 122° F (10° to 50° C)	
		Non-operating temperature	-22° to 140° F (-30° to 60° C)	
		Operating humidity	10% to 90% (non-condensing at ambient)	
		Non-operating humidity	20% to 80% (non-condensing at ambient)	
		Operating shock	40 g, six surfaces	
		Non-operating shock	80 g, six surfaces	
		Operating vibration	2-g peak acceleration	
		Non-operating vibration	4-g peak acceleration	
	Approvals	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
Drop (in box)		42 in (107 cm) on concrete, 16-drop sequence		
Ergonomic compliance		UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC ANSI HFS 100, ISO 9241-4, and TUVGS		
HP USB Smartcard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
		Form factor	USB basic Smart Card keyboard	
		Colors	Carbonite/Silver	
		Dimensions (H x W x D)	18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)	

Technical Specifications - Input/Output Devices

Electrical	Weight	2 lb (0.9 kg) minimum
	Operating voltage	+ 5VDC \pm 5%
	Power consumption	100-mA maximum (with four LEDs ON)
	System interface	USB Type A plug connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
Mechanical	Microsoft PC 99 - 2001	Functionally compliant
	Languages	30+ available
	Keycaps	Low-profile design
	Switch actuation	55 g nominal peak force with tactile feedback
	Switch life	20 million keystrokes (using Hasco modified tester)
	Switch type	Contamination-resistant membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)
	Microsoft PC 99 - 2001	Mechanically compliant
	Acoustics	43-dBA maximum sound pressure level
Environmental	Operating temperature	50° to 122° F (10° to 50° C)
	Non-operating temperature	-22° to 140° F (-30° to 60° C)
	Operating humidity	10% to 90% (non-condensing at ambient)
	Non-operating humidity	20% to 80% (non-condensing at ambient)
	Operating shock	40 g, six surfaces
	Non-operating shock	80 g, six surfaces
	Operating vibration	2-g peak acceleration
	Non-operating vibration	4-g peak acceleration
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence
SMARTCARD function	Support	All ISO 7816 smart cards
	Interface	Reads from and writes to all ISO7816-1, 2, 3, 4 memory and microprocessor smart cards (T=0, T=1)
	Chipset	SCM STCII
	Standard APIs supported	PC/SC, EMV2000, SET
	Power	USB Port Short circuit detection (protects smart card and reader) Power supply compliant with ISO7816 and EMV (5V, 60 mA) Supports 3-V and 5-V cards

Technical Specifications - Input/Output Devices

Power consumption	250-mA maximum draw (50 mA for the keyboard with three LEDs ON and 200-mA maximum startup current using a high-current, 60-mA smart card)		
Communication	From card	Programmable from 9,600 baud to 115,200 baud	
	From computer	Up to 38,400 baud	
Landing mechanism	Contact device	Friction contact	
	Card insertions rating	Up to 100,000 insertion cycles	
Interface modes	USB communications through USB port SCM protocol Automatic card insertion/removal detection		
Reader performance interface	USB connection		
Electro-magnetic standards	Europe	89/336/CEE guideline	
	USA	USAFCC part 15	

HP USB 2-Button Laser Mouse

Scroll Wheel	24		
Maximum Rotation Speed	48 rats/sec		
Switch Type	wheel		
Switch Life	Button - 3,000,000 Wheel - 1,000,000 times Tilt switch - 500,000 times		
Environmental	Operating Temperature	32° to 104° F (0° to 40° C)	
	Non-operating Temperature	-4° to 140° F (-20° to 60° C)	
	Operating Humidity	10% to 90% (non-condensing at ambient)	
	Non-operating Humidity	20% to 80% (non-condensing at ambient)	
	Operating Shock	40 g, six surfaces	
	Non-operating Shock	80 g, six surfaces	
	Operating Vibration	2-g peak acceleration	
	Non-operating Vibration	4-g peak acceleration	
Electrical	Operating Voltage	+ 5VDC ± 5%	
	Power Consumption		
	MTBF	> 150,000 hrs	
	ESD	IEC-61000-4-2 criteria B, Contact discharge: +/- 4kV, Air discharge: +/- 8kV	
	EMI-RFI	FCC Class B	
	PC98	PC 99 Compliant	
Mechanical	Resolution	800dpi	

Technical Specifications - Input/Output Devices

	Tracking Speed	25 cm/sec
	Acceleration	0.5mm
	Switch Actuation	0.6N (60gf)
	Switch Life	Button - 3,000,000 Wheel - 1,000,000 times Tilt switch - 500,000 times
	Cable Length	1850mm
	PC98-99	PC99 compliant
Regulatory Approvals		UL60950-1, UL 94, UL 746 (A-E), UL 796 TUV/GS: EN 60950-1, EN 60825-1 FCC Class B, UL 1950, cUL, TUV GS, CE, C-tick, VCCI, BSMI, RRL

HP PS/2 Optical Scroll Mouse	Dimensions (H x L x W)	3.95 x 6.21 x 11.7 cm (1.56 x 2.44 x 4.61 in)	
	Weight	4.44 oz (126 g)	
	Environmental	Operating temperature	-32° to 104°F (0° to 40° C)
		Non-operating temperature	-4° to 140°F (-20° to 60° C)
		Operating humidity	10% to 90% (non condensing at ambient)
		Non-operating humidity	10% to 90% non condensing
		Operating shock	40 g, 6 surfaces
		Non-operating shock	80 g, 6 surfaces
		Operating vibration	2 g peak acceleration
		Non-operating vibration	4 g peak acceleration
		Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face
		Electrical	Operating voltage
	Power consumption		100mA
	System consumption		PS/2 mini-din connector
	ESD		CE level 4, 15 kV air discharge
	EMI-RFI		Conforms to FCC rules for a Class B computing device
	Mechanical	Microsoft PC99 - 2001	Functionally compliant
		Resolution	400 ± 20% DPI
		Tracking speed	10 in/s (25.4 cm/s) maximum
		Acceleration	100 in/s/s (2.54 m/s/s)
Switch actuation		61 g nominal peak force	
Switch life		3,000,000 operations (using Hasco modified tester)	
Switch type		Low force micro-switches	
Tracking mechanism life		155 mi (250 km) at average speed of 10 in/s	

Technical Specifications - Input/Output Devices

	Cable length	6 ft (1.8 m)
	Microsoft PC99 - 2001	Mechanically compliant
Scroll wheel	Width	8 mm
	Diameter	1.01 in (25.6 mm)
	Maximum rotation speed	48 rats/sec
	Switch type	Light force micro-switch
	Switch life	1 million operations
	Mechanical life	Minimum 200,000 revolutions
Regulatory approvals	Compliant	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

HP USB Optical Scroll Mouse	Dimensions (H x L x W)	1.5 x 4.5 x 2.5 in (3.8 x 11.6 x 6.3 cm)
	Weight	0.27 lb (0.12 kg)
	Cable length	72.8 in (185 cm)

Technical Specifications - Optical Storage

HP SATA Blu-ray Writer	Height	5.25-inch, half-height, tray-load			
	Orientation	Either horizontal or vertical			
	Interface type	SATA/ATAPI			
	Disc capacity	50 GB DL or 25 GB standard			
	Dimensions (W x H x D)	5.9 x 1.7 x 7.5 in (15.0 x 4.4 x 19.0 cm)			
	Weight (max)	2.0 lb (907g)			
Write speed	BD-R	Single-layer	2x, 4x CLV, 6x CAV		
		Double-layer	2x, 4x CLV		
	BD-RE	Single-layer	2.3x		
	DVD-R	Single-layer	2x, 4x CLV, 8x ZCLV, 8x, 12x PCAV, 16x CAV		
	DVD-RW	Single-layer	1x, 2x, 4x, 6x CLV		
	DVD+R	Single-layer	2.4x, 4x CLV, 8x ZCLV, 8x, 12x PCAV, 16x CAV		
	DVD+RW	Single-layer	2.4x, 4x, 6x CLV, 8x ZCLV		
	DVD-RAM	Single-layer	2x, 3x CLV, 3-5x PCAV		
	CD-R	Single-layer	8x, 16x CLV, 24x, 32x PCAV, 40x CAV		
	CD-RW	Single-layer	4x, 10x, 16x CLV, 24x ZCLV		
	Read speeds	BD-ROM	Single-layer	6x CAV	
		BD-R	Single-layer	6x CAV	
		BD-RE (SL/DL)	Single-layer	4.8x CAV	
		DVD-ROM	Single-layer	16x CAV	
		DVD-R	Single-layer	12x CAV	
		DVD-RW	Single-layer	10x CAV	
		DVD+R	Single-layer	12x CAV	
		DVD+RW	Single-layer	10x CAV	
BDMV (AACs Compliant Disc)		Single-layer	4.8x CAV		
DVD-RAM		Single-layer	2x, 3x CLV, 3x-5x PCAV		
DVD-Video (CSS Compliant Disc)		Single-layer	8x CAV		
CD-R/RW/ROM		Single-layer	40x / 40x / 40x CAV		
CD-DA (DAE)		Single-layer	32x CAV		
80 mm CD		Single-layer	16x CAV		
Sustained Transfer rate		BD-ROM	Single-layer	215.79 Mbits/s (6x) max.	
		DVD-ROM	Single-layer	16.62 Mbytes/s (16x) max.	
		CD-ROM	Single-layer	6,000 KB/s (40x) max.	

Technical Specifications - Optical Storage

Burst Transfer rate		1.5Gbps bits/s (10b side) 1.2Gbps bits/s (8b side)
Multimedia MPC-3 compliant		Yes
Access times (typical reads, including setting)	Random	DVD: < 140 ms (typical), CD: < 125 ms (typical)
	Full Stroke	DVD: < 250 ms (seek), CD: < 210 ms (seek)
Power	Source	SATA DC power receptacle
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p
	DC Current	5 VDC -1000 mA typical, 1600 mA maximum 12 VDC -600 mA typical, 1400 mA maximum
Environmental (all conditions non-condensing)	Temperature (operating)	41° to 122° F (5° to 50° C)
	Relative Humidity (operating)	10% to 90%
	Maximum Wet Bulb Temperature (operating)	86° F (30° C)

HP SATA SuperMulti DVD Writer Drive	Height	5.25-inch, half-height, tray-load	
	Orientation	Either horizontal or vertical	
	Interface type	SATA/ATAPI	
	Disc capacity	8.5 GB DL or 4.7 GB standard	
	Dimensions (W x H x D)	5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)	
	Weight (max)	2.6 lb (1.2 kg)	
	Write speeds	DVD-RAM	Up to 12X
		DVD+R	Up to 16X
		DVD+RW	Up to 8X
		DVD+R DL	Up to 8X
		DVD-R DL	Up to 8X
		DVD-R	Up to 16X
		DVD-RW	Up to 6X
		CD-R	Up to 48X
		CD-RW	Up to 32X
		Read speeds	DVD-RAM
DVD+RW, DVD-RW, DVD+R DL, DVD-R DL	Up to 8X		
DVD-ROM DL	Up to 8X		
DVD-ROM, DVD+R, DVD-R	Up to 16X		
CD-ROM, CD-R	Up to 48X		
CD-RW	Up to 32X		

Technical Specifications - Optical Storage

Access time (typical reads, including settling)	Random	DVD: < 140 ms (typical), CD: < 125 ms (typical)
	Full Stroke	DVD: < 250 ms (seek), CD: < 210 ms (seek)
Power	Source	SATA DC power receptacle
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p
	DC Current	5 VDC (< 1000 mA typical, 1600 mA maximum) 12 VDC (< 600 mA typical, 1400 mA maximum)
Environmental conditions (operating - non-condensing)	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 90%
	Maximum Wet Bulb Temperature	86° F (30° C)

SATA DVD-ROM Drive	Height	5.25-inch, half-height, tray-load		
	Orientation	Either horizontal or vertical		
	Interface type	SATA/ATAPI		
	Disc capacity	Single layer: Up to 4.7 GB (6 times capacity of CD-ROM) Double layer: Up to 8.5 GB (12 times capacity of CD-ROM)		
	Dimensions (W x H x D)	5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)		
	Weight (max)	2.6 lb (1.2 kg)		
	Read speeds	DVD+R/-R/+RW/-RW/+R DL /-R DL	Up to 8X	
		DVD-ROM	Up to 16X	
		DVD-RAM	Up to 4X	
		CD-ROM, CD-R	Up to 40X	
		CD-RW	Up to 32X	
		Removable Storage - Media Compatibility - DVD-ROM	Media	Read
	CD-ROM		Yes	No
	CD-R		Yes	No
CD-RW	Yes		No	
DVD-ROM	Yes		No	
DVD-ROM DL	Yes		No	
DVD-RAM	Yes		No	
DVD+R	Yes		No	
DVD+R DL	Yes		No	
DVD+RW	Yes		No	
DVD-R	Yes		No	
DVD-RW	Yes		No	
DVD-R DL	Yes	No		
Access times	Random	DVD: < 140 ms (typical), CD: < 125 ms (typical)		

Technical Specifications - Optical Storage

(typical reads, including setting)	Full Stroke	DVD: < 250 ms (seek), CD: < 210 ms (seek)
	Cache Buffer	2 MB (minimum)
	Data Transfer Modes	ATA PIO mode 4 (16.7 MB/s); ATA Multi-word DMA mode 2 (16.7 MB/s); ATA UltraDMA Mode 3 (44.4 MB/s -default)
Power	Source	SATA DC power receptacle
	DC Power Requirement	5 VDC \pm 5%-100 mV ripple p-p 12 VDC \pm 5%-200 mV ripple p-p
	DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum 12 VDC -< 600 mA typical, < 1400 mA maximum
Environmental (all conditions non-condensing)	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 90%
	Maximum Wet Bulb Temperature	86° F (30° C)

Technical Specifications - Removable Storage

HP 22-in-1 (with 1394) Media Card Reader

USB Interface

USB 2.0 High-speed interface

NOTE: Requires the USB cable to be connected to the internal USB 2.0 port or a USB 2.0 PCI card.

1394 Interface

Two IEEE-1394a external ports; 1 IEEE-1394a internal port (connects to the pass through cable on the media card reader)

Advance protocol support

- Supports hardware ECC (Error Correction Code) function
- Supports hardware CRC (Cyclic Redundancy Check) function
- Supports MS 4-bit parallel transfer mode
- Supports MS-PRO 4-bit parallel transfer mode
- Supports MS PRO-HG Duo 4-bit parallel transfer mode
- Supports SD 4-bit parallel transfer mode
- Supports high-speed 50Mhz SD 4-bit card (version 2.0)
- Supports high-speed 52Mhz MultiMediaCard 8-bit card (version 4.2)
- Supports CF v4.0 with PIO mode 6 and Ultra DMA mode

Supported media type

- CompactFlash Type I
- CompactFlash Type II
- Microdrive
- MultiMediaCard
- Reduced Size MultiMediaCard (RS MultiMediaCard)
- MultiMediaCard 4.2 (MultiMediaCard Plus, including MultiMediaCard Plus HC)
- Reduced Size MultiMediaCard 4.2 (MultiMediaCard Mobile, including MultiMediaCard Mobile HC)
- Secure Digital Card (SD)
- Secure Digital High Capacity (SDHC)
- miniSD
- miniSD High Capacity
- Micro SD (T-Flash)
- Micro SD HC
- Memory Stick
- Memory Stick Select
- Memory Stick Duo (MS Duo)
- Memory Stick PRO (MS PRO)
- Memory Stick PRO Duo (MS PRO Duo)
- Memory Stick PRO-HG Duo
- MagicGate Memory Stick (MG)
- MagicGate Memory Stick Duo
- Picture Card

Supported media type with card adapter

- Memory Stick Micro (M2)
- MultiMediaCard Micro

Environmental

Operational

Environmental Extremes

Test Parameters/Conditions - Power applied, unit operating on system $\pm 5\%$ nominal supply voltage.
 10°C 10% R.H. = 24 hours
 10°C 90% R.H. = 24 hours
 20°C 90% R.H. = 24 hours
 30°C 90% R.H. = 24 hours
 40°C 90% R.H. = 24 hours

Technical Specifications - Removable Storage

		50°C 90% R.H. = 24 hours
		50°C 10% R.H. = 24 hours
	Storage Environmental Extremes	Test Parameters/Conditions
		140°F (60°C) @ 80% R.H. for 96 hours
		-22°F (-30°C) @ 20% R.H. for 48 hours
		No power applied
		Delta °C < 1.0°C/min
		Delta % R.H. < 1.5% R.H./min
Approvals		USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3
		FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUV-T

Technical Specifications - Environmental Data

Microtower

Eco-Label Certifications and declarations This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US Energy Star
- IT ECO declaration
- EPEAT – Gold

System Configuration The configuration used for the Energy Consumption and Declared Noise Emissions data for the Microtower model is based on a typically configured product.

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	30.1794 W	30.3597 W	30.4591 W
Sleep (Energy Star low power mode)	2.4888 W	2.6405 W	2.4643 W
Off	0.7565 W	0.8930 W	0.7409 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	103 BTU/hr	104 BTU/hr	104 BTU/hr
Sleep	8 BTU/hr	9 BTU/hr	8 BTU/hr
Off	3 BTU/hr	3 BTU/hr	2 BTU/hr

* Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions

(in accordance with ISO 7779 and ISO 9296)

	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
System Fan Off		
Idle	3.8	27
Fixed Disk (random writes)	3.8	28

Batteries This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Li Ion

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net

Technical Specifications - Environmental Data

- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% post consumer recycled plastic (by wt.)
- This product is 91.3% recyclable when properly disposed of at end of life.

Packaging Materials	External	
	Corrugated Paper	1835 g
	Internal	
	Polyethylene low density solid	150 g
	Polyethylene low density foam	20 g

- The Polyethylene low density foam packaging material is made from 100% recycled content.
- The Polyethylene low density Solid packaging material is made from 100% recycled content.
- The corrugated packaging material contains at least 30% recycled content.

Small Form Factor

Eco-Label Certifications & declarations This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US Energy Star
- IT ECO declaration
- EPEAT – Silver

System Configuration The configuration used for the Energy Consumption and Declared Noise Emissions data for the Small Form Factor model is based on a typically configured product.

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	29.5659 W	28.7916 W	29.1392 W
Sleep (Energy Star low power mode)	2.4243 W	2.6419 W	2.4196 W
Off	0.7496 W	0.9092 W	0.7371 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	101 BTU/hr	98 BTU/hr	100 BTU/hr
Sleep	8 BTU/hr	9 BTU/hr	8 BTU/hr
Off	2 BTU/hr	3 BTU/hr	3 BTU/hr

* Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions

(in accordance with ISO 7779 and ISO 9296)

	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
System Fan Off		
Idle	3.8	27
Fixed Disk (random writes)	3.9	28

Technical Specifications - Environmental Data

Batteries This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Li Ion

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Silver level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% post consumer recycled plastic (by wt.)
- This product is 95.1% recyclable when properly disposed of at end of life.

Packaging Materials

External

Corrugated Carton 1705 g

Internal

EPE-Expanded Polyethylene 198 g

Polyethylene low density foam 39 g

- The EPE-Expanded Polyethylene packaging material is made from 100% recycled content.
- The Polyethylene low density foam packaging material is made from 100% recycled content.
- The Corrugated Carton packaging materials contains at least 75% recycled content.

Small Form Factor and Microtower

RoHS Compliance

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes

Technical Specifications - Environmental Data

- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <http://www.hp.com/go/recyclers>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

<http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html>

Eco-label certifications

<http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html>

ISO 14001 certificates:

<http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html>

Technical Specifications - Environmental Data

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